Dual supply 1-of-2 VGA switch

Rev. 2 — 4 November 2011

Product data sheet

1. General description

The NX5DV4885E is a dual supply 1-to-2 VGA switch. It integrates high-bandwidth SPDT switches with level translating switches and level translating buffers to provide switching of input RGB signals and switching and level translation of input DDC signals to either of two output channels as well as level translation of input H-sync and V-sync signals

The NX5DV4885E is characterized for operation from –40 °C to +85 °C.

2. Features and benefits

- RGB switches:
 - Low ON resistance (4 Ω typical)
 - Low ON capacitance (12 pF typical)
 - Low output skew (50 ps)
- Low power consumption (< 2 μA)</p>
- Level translation of sync and DDC signals
- Over-voltage tolerant inputs
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 4 kV
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101D exceeds 1000 V
 - IEC61000-4-2 contact discharge exceeds 4 kV for I/Os
- Latch-up performance exceeds 100 mA per JESD78 Class II Level A
- Specified from –40 °C to +85 °C

3. Applications

- Notebook Computers
- Docking stations
- Digital projectors
- Computer monitors
- Servers
- Storage



4. Ordering information

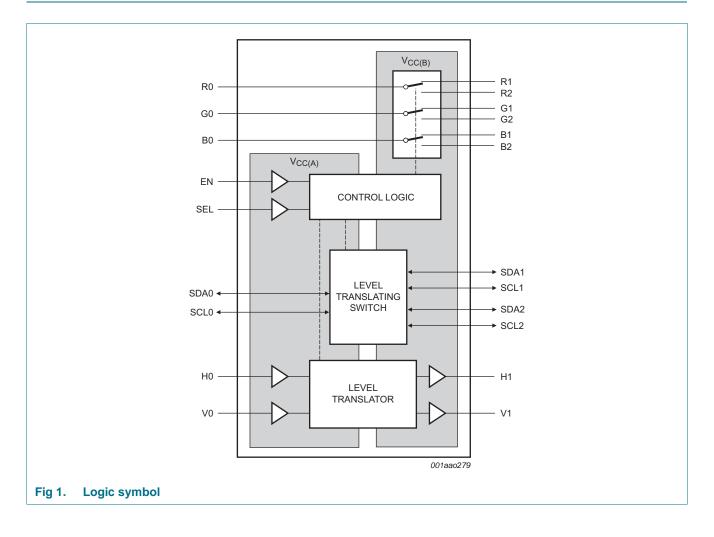
Table 1. Orderi	ng information			
Type number	Package			
	Temperature range	Name	Description	Version
NX5DV4885EHF	–40 °C to +85 °C	HVQFN24	plastic thermal enhanced very thin quad flat package; no leads; 24 terminals; body $4\times4\times0.85$ mm	SOT616-3

5. Marking

Table 2. Marking codes	
Type number	Marking ^[1]
NX5DV4885EHF	x5E

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

6. Functional diagram



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Pinning information 7.

7.1 Pinning

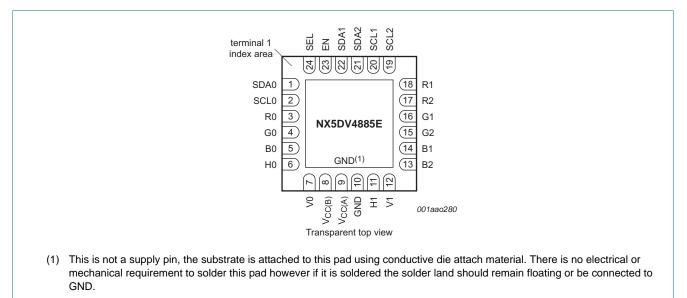


Fig 2. Pin configuration SOT616-3 (HVQFN24)

7.2 Pin description

Pin description Table 3.

Symbol	Pin	Description
R0, G0, B0	3, 4, 5	RGB input or output
GND	10	ground (0 V)
V _{CC(A)}	9	supply voltage A
H0	6	horizontal sync input
VO	7	vertical sync input
EN	23	enable input (active HIGH)
SDA0	1	SDA0 input or output
SCL0	2	SCL0 input or output
SDA1, SDA2	22, 21	SDA input or output
SCL1, SCL2	20, 19	SCL input or output
V _{CC(B)}	8	supply voltage B
V1	12	vertical sync output
H1	11	horizontal sync output
R1, G1, B1, R2, G2, B2	18, 16, 14, 17, 15, 13	RGB input or output
SEL	24	select input

8. **Functional description**

The NX5DV4885E integrates high-bandwidth SPDT switches, level-translating buffers and level translating SPDT switches to provide a complete solution for 1-to-2 switching of VGA signals. An enable input (EN) is used to enable or disable the device and a select input (SEL) is used to determine which output is selected. When EN = LOW the device is disabled; all switches will be off and H1, V1 will be forced LOW.

8.1 RGB switches

The NX5DV4885E provides three identical single pole double throw high-bandwidth switches to route standard VGA RGB signals (see Table 4).

Table 4.	Function table RGB
H = HIGH	voltage level: $I = I OW$ voltage level: $X = Don't$ care.

	renage level	
Input		Switch
EN	SEL	
Н	L	R0 to R1; G0 to G1; B0 to B1
Н	Н	R0 to R2; G0 to G2; B0 to B2
L	Х	switches Rn, Gn, Bn off

8.2 H-Sync/V-Sync level translator

The horizontal and vertical synchronization buffers have inputs (H0, V0) referenced to V_{CC(A)} and outputs (H1 and V1) that are referenced to V_{CC(B)}. This allows level translation of synchronization signals from as low as 2.0 V up to 5.5 V and supports low-voltage CMOS or TTL-compatible graphics controllers meeting the VESA specification for output drive of ±8 mA. The EN input also controls the level shifter (See Table 5).

Table 5. **Function table HV**

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

Input	Switch
EN	
Н	H1 = H0; V1 = V0
L	H1, V1 = L

Product data sheet

8.3 Display-Data Channel Multiplexer

The NX5DV4885E provides two identical SPDT active-level translating switches to route DDC signals (See <u>Table 6</u>). The switch outputs are limited to a diode drop below the voltage applied on $V_{CC(A)}$. To provide VESA I²C-compatible signals 3.3 V should be applied to $V_{CC(A)}$. If voltage translation is not required $V_{CC(A)}$ should be connected to $V_{CC(B)}$.

Table 6.Function table DDCH = HIGH voltage level; L = LOW voltage level; X = Don't care.

Input		Switch
EN	SEL	
н	L	SDA0 to SDA1, SCL0 to SCL1
Н	Н	SDA0 to SDA2, SCL0 to SCL2
L	Х	switches SDAn, SCLn off

9. Limiting values

Table 7. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

					,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		-0.5	+6	V
V _{CC(B)}	supply voltage B		-0.5	+6	V
VI	input voltage		<u>[1]</u> –0.5	+6	V
V _{SW}	switch voltage		<u>[1]</u> –0.5	+6	V
l _{IK}	input clamping current	$V_{I} < -0.5 V$	-50	-	mA
I _{SK}	switch clamping current	$V_{I} < -0.5 V$	-50	-	mA
I _{OK}	output clamping current	$V_{O} < 0 V$	-50	-	mA
lo	output current	$V_{O} = 0 V$ to $V_{CC(B)}$	-	±50	mA
I _{CC}	supply current	I _{CC(A)} or I _{CC(B)}	-	100	mA
I _{GND}	ground current		-100	-	mA
I _{SW}	switch current	V_{SW} > -0.5 V or V_{SW} < 6 V; source or sink current	-	±30	mA
		V_{SW} > -0.5 V or V_{SW} < 6 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±90	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +85 \text{ °C}$	[2] _	300	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] For HVQFN24 package: above 134.5 °C the value of P_{tot} derates linearly with 19.3 mW/K.

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10. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC(A)}	supply voltage A		2	3.3	5.5	V
V _{CC(B)}	supply voltage B		4.5	5.0	5.5	V
T _{amb}	ambient temperature	operating in free-air	-40	+25	+85	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$	<u>[1]</u> -	20	-	ns/V
		$V_{CC(A)} = 3 V \text{ to } 3.6 V$	<u>[1]</u> -	10	-	ns/V
		$V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V}$	<u>[1]</u> _	5	-	ns/V

[1] Applies to control signal levels.

11. Static characteristics

Table 9. Static characteristics

 $V_{CC(B)}$ = 4.5 V to 5.5 V; $V_{CC(A)}$ = 2 V to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		T _{amb} = –40 °C to +85 °C			
				Min	Typ[1]	Max	
General							
I _{CC(A)}	supply current A	$V_{CC(A)}$ = 3.3 V; EN = $V_{CC(A)}$ or GND; for H1, V1: I_{O} = 0 A		-	-	2.0	μA
I _{CC(B)}	supply current B	$V_{CC(B)}$ = 5.0 V; EN = $V_{CC(A)}$ or GND; for H1, V1: I_O = 0 A		-	-	2.0	μA
HV buffe	r						
V _{IH}	HIGH-level input voltage	$V_{CC(A)} = 3 V \text{ to } 3.6 V$		2	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC(A)} = 3 V \text{ to } 3.6 V$		-	-	0.8	V
V _H	hysteresis voltage			-	50	-	mV
lı	input leakage current			-	-	±1	μA
V _{OH}	HIGH-level output voltage	$I_{O} = -8 \text{ mA}$		V _{CC(B)} - 0.5	-	-	V
V _{OL}	LOW-level output voltage	I _O = 8 mA		-	-	0.5	V
I _{OFF}	power-off leakage current			-	-	±1	μA
RGB swi	tches						
I _{S(OFF)}	OFF-state leakage current			-	-	±1	μΑ
I _{S(ON)}	ON-state leakage current			-	-	±1	μΑ
R _{ON}	ON resistance	$V_I = 0.7 \text{ V}; I_{SW} = -10 \text{ mA}; \text{See } \frac{\text{Figure 5}}{\text{Figure 6}}$ and $\frac{\text{Figure 6}}{\text{Figure 6}}$	<u>[4]</u>	-	4	-	Ω
ΔR_{ON}	ON resistance mismatch between channels	$V_{\rm I}$ = GND to 0.7 V; $I_{\rm SW}$ = –10 mA	[2]	-	0.5	-	Ω
R _{ON(flat)}	ON resistance (flatness)	$V_I = GND$ to 0.7 V; $I_{SW} = -10$ mA	<u>[3]</u>	-	0.5	-	Ω
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Symbol	Parameter	Conditions		T _{amb} = -40 °C to +85 °C			Unit
			Ť	Min	Typ <mark>[1]</mark>	Max	-
C _{S(OFF)}	OFF-state capacitance			-	4.5	-	pF
C _{S(ON)}	ON-state capacitance			-	12	-	pF
SDA, SC	L						
I _{S(OFF)}	OFF-state leakage current		<u>[5]</u>	-	-	±1	μA
R _{ON}	ON resistance	$V_{CC(A)} = 2 \text{ V}; \text{ V}_{I} = 0.4 \text{ V}; \text{ I}_{SW} = \pm 2 \text{ mA};$ See <u>Figure 5</u> and <u>Figure 7</u>		-	9	-	Ω
C _{S(ON)}	ON-state capacitance			-	15	-	pF
Control I	_ogic (SEL, EN)						
VIH	HIGH-level input voltage	$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$		1.7	-		V
		$V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$		2.0	-		V
		$V_{CC(A)} = 4.5 V \text{ to } 5.5 V$		0.7V _{CC(A)}	-		V
V _{IL}	LOW-level input voltage	$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$		-	-	0.7	V
		$V_{CC(A)} = 3.0 \text{ V to } 3.6 \text{ V}$		-	-	0.8	V
		$V_{CC(A)} = 4.5 V \text{ to } 5.5 V$		-	-	$0.3V_{CC(A)}$	V
V _H	hysteresis voltage			-	50	-	mV
l _l	input leakage current	$V_{CC(A)} = 5.5 \text{ V}; \text{ V}_{I} = \text{GND to } V_{CC(A)}$		-	-	±1	μA

Table 9. Static characteristics ... continued

[1] All typical values are measured at $V_{CC(B)} = 5$ V, $V_{CC(A)} = 3.3$ V and $T_{amb} = 25$ °C unless otherwise specified.

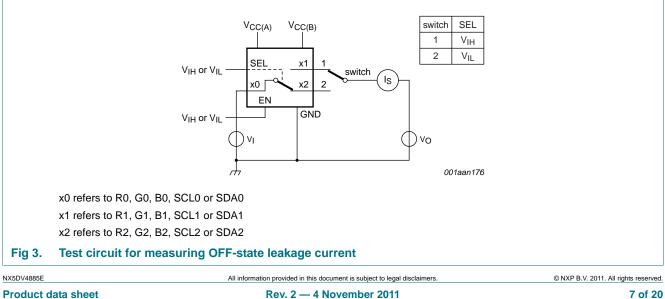
[2] Measured at identical V_{CC}, temperature and input voltage.

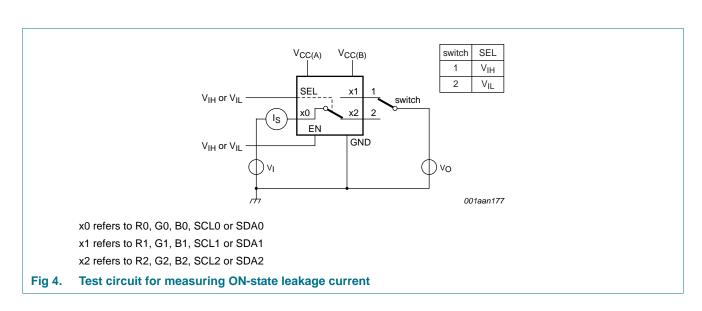
Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and [3] temperature.

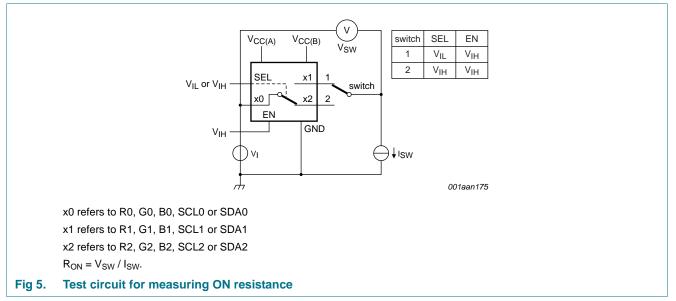
[4] Guarantees the LOW level.

Guarantees the HIGH level. [5]

11.1 Test circuits and waveforms







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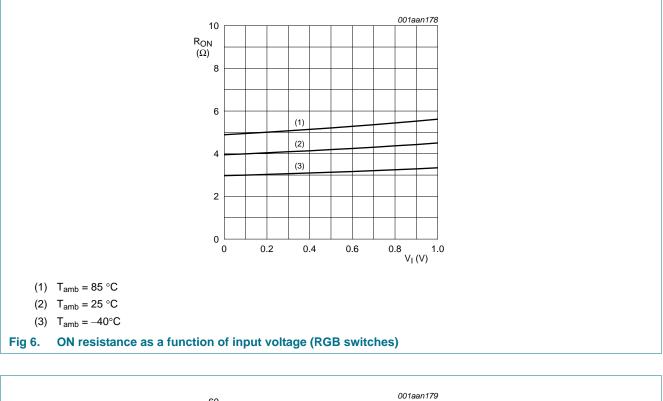
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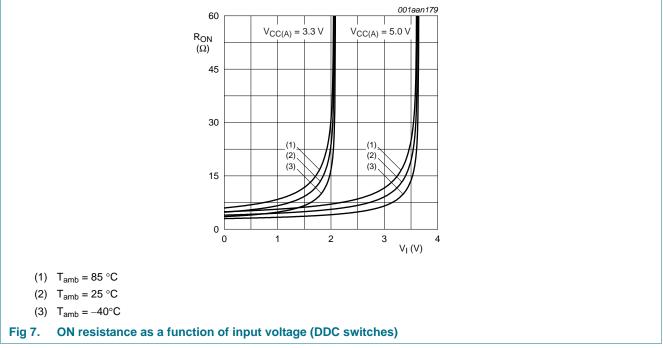
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12. Dynamic characteristics

Table 10. Dynamic characteristics

At recommended operating conditions; Voltages are referenced to GND (ground = 0 V; $V_{CC(B)}$ = 4.5 V to 5.5 V; $V_{CC(A)}$ = 2 V to 5.5 V.

Symbol	Parameter	Conditions	IS			T _{amb} = –40 °C to +85 °C			
				Min	Typ <mark>[1]</mark>	Max			
t _{pd}	propagation delay	H0 to H1 and V0 to V1; See <u>Figure 8</u> and <u>Figure 9</u>	[2]	-	3	-	ns		
t _{en}	enable time	EN and SEL to all other outputs; See <u>Figure 10</u> and <u>Figure 11</u>		-	15	-	ns		
t _{dis}	disable time	EN and SEL to all other outputs; See <u>Figure 10</u> and <u>Figure 11</u>		-	5	-	ns		
t _{b-m}	break-before-make time	See Figure 12		-	10	-	ns		
t _{sk(o)}	output skew time	Skew between any Rn, Gn and Bn ports; see <u>Figure 8</u>	<u>[3]</u>	-	50	-	ps		

[1] All typical values are measured at $V_{CC(B)} = 5 \text{ V}$; $V_{CC(A)} = 3.3 \text{ V}$; $T_{amb} = 25 \text{ °C}$.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Guaranteed by design.

12.1 Test circuits and waveforms

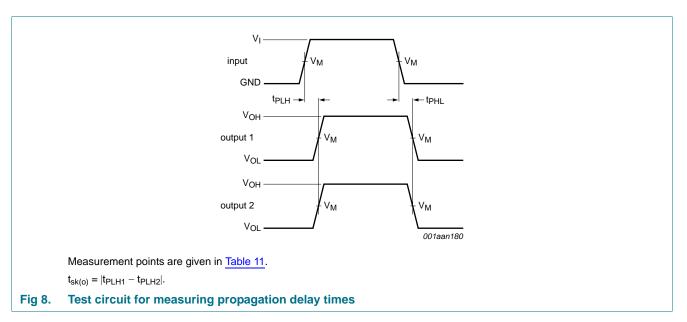


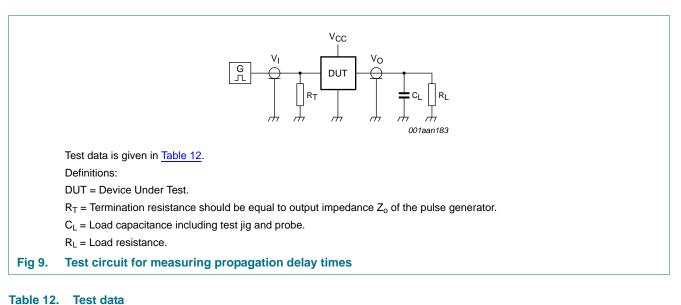
Table 11. Measurement points

Input		Output		
V _M	VI	V _X	V _M	
0.5V _{CC(A)}	GND to V _{CC(A)}	0.9V _{OH}	0.5V _{CC(B)}	

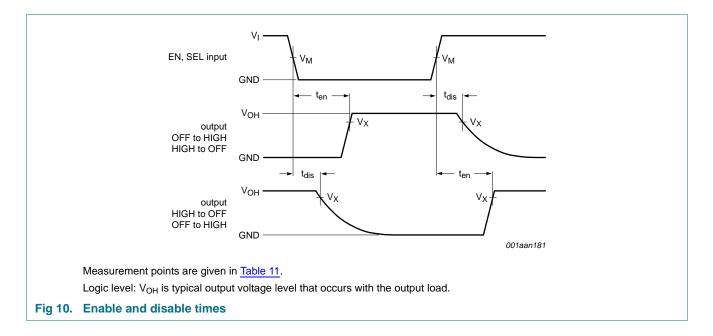
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Input Load t_r, t_f C_L R_L ≤ 2.5 ns 10 pF 1 kΩ





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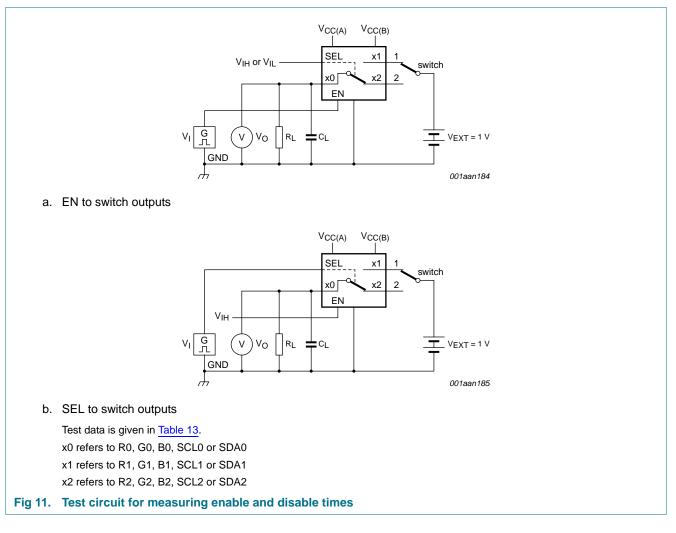
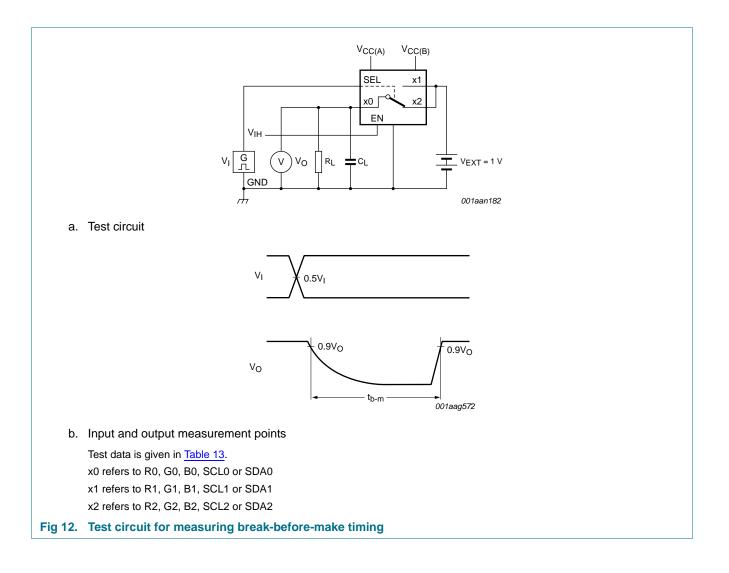


Table 13. Test data

Input		Load		
t _r , t _f	VI	CL	RL	
≤ 2.5 ns	GND to V _{CC(A)}	10 pF	100 Ω	

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Dual supply 1-of-2 VGA switch



13. Additional dynamic characteristics

Table 14. Additional dynamic characteristics

 $V_{CC(B)}$ = 5.0 V ± 10 %, $V_{CC(A)}$ = 2 V to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		T _{amb} = -40 °C to +85 °C			Unit
				Min	Тур	Max	
f _(-3dB)	-3 dB frequency response	$R_L = 50 \Omega;$ see Figure 13	1]	-	850	-	MHz
α_{ins}	Insertion loss	$f_i = 1 \text{ MHz}; R_L = R_S =$ 50 Ω; see Figure 13		-	0.6	-	dB
Xtalk	crosstalk	between switches; $f_i = 50 \text{ MHz}$; $R_L = 50 \Omega$; see Figure 13	1]	-	-50	-	dB

[1] f_i is biased at 0.5V_{CC}.

13.1 Test circuits

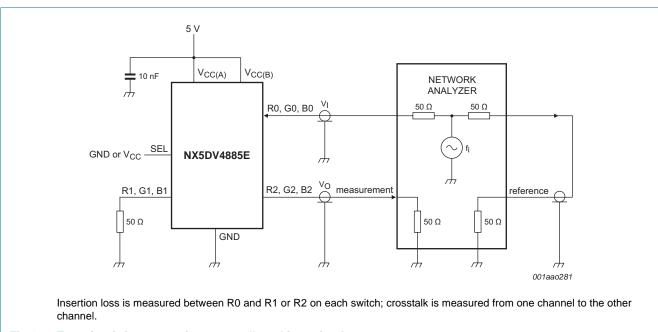
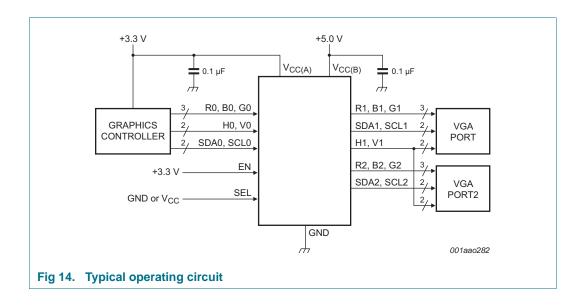


Fig 13. Test circuit for measuring crosstalk and insertion loss

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14. Application information

The NX5DV4885E provides the level shifting necessary to drive two standard VGA ports from a graphic controller as low as 2.2 V. Internal buffers drive the HSYNC and VSYNC signals to VGA standard TTL levels. The DDC multiplexer provides level shifting by clamping signals to a diode drop below the voltage applied on V_{CC(A)} (See figure Figure 14). Connect V_{CC(A)} to 3.3 V for normal operation, or to V_{CC(B)} to disable voltage clamping for DDC signals



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15. Package outline

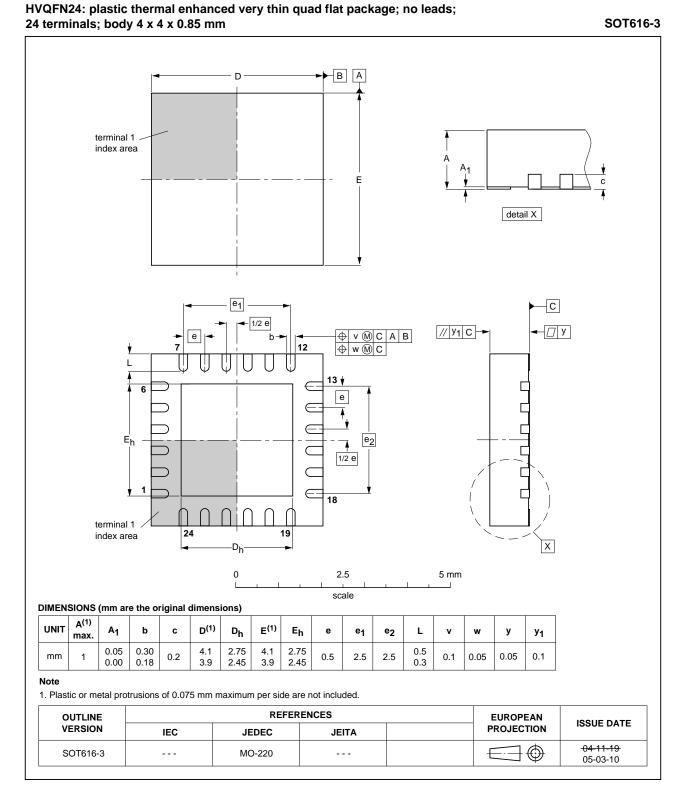


Fig 15. Package outline SOT616-3 (HVQFN24)

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16. Abbreviations

Table 15.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DDC	Display Data Channel
ESD	ElectroStatic Discharge
HBM	Human Body Model
KVM	Keyboard Video Mouse
MM	Machine Model
RGB	Red Green Blue
SPDT	Single Pole Double Throw
TTL	Transistor-Transistor Logic
VESA	Video Electronics Standards Association

17. Revision history

Table 16. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
NX5DV4885E v.2	20111104	Product data sheet	-	NX5DV4885E v.1
Modifications:	 Legal pages 	updated.		
NX5DV4885E v.1	20110719	Product data sheet	-	-

18. Legal information

18.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Date of release: 4 November 2011 Document identifier: NX5DV4885E